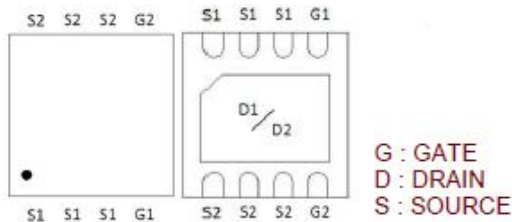


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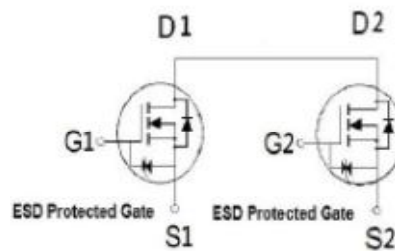
Dual N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
20V	8.5mΩ @ $V_{GS} = 4.5V$	39A



PDFN 3X3S



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	20	V
Gate-Source Voltage		V_{GS}	±8	
Continuous Drain Current ²	$T_C = 25\text{ }^{\circ}\text{C}$	I_D	39	A
	$T_C = 100\text{ }^{\circ}\text{C}$		24	
	$T_A = 25\text{ }^{\circ}\text{C}$		12	
	$T_A = 70\text{ }^{\circ}\text{C}$		9.7	
Pulsed Drain Current ¹		I_{DM}	60	
Avalanche Current		I_{AS}	23.5	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	27.6	mJ
Power Dissipation	$T_C = 25\text{ }^{\circ}\text{C}$	P_D	23	W
	$T_C = 100\text{ }^{\circ}\text{C}$		9.4	
	$T_A = 25\text{ }^{\circ}\text{C}$		2.2	
	$T_A = 70\text{ }^{\circ}\text{C}$		1.4	
Operating Junction & Storage Temperature Range		T_J, T_{stg}	-55 to 150	$^{\circ}\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ³	$R_{\theta JA}$		55	$^{\circ}\text{C} / \text{W}$
Junction-to-case	$R_{\theta JC}$		5.3	

¹Pulse width limited by maximum junction temperature.

²Package limitation current is 24A.

³The value of $R_{\theta JA}$ is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^{\circ}\text{C}$.

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Dual N-Channel Enhancement Mode MOSFET

ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	20			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	0.35	0.67	1	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±8V			±30	uA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 16V, V _{GS} = 0V			1	μA
		V _{DS} = 10V, V _{GS} = 0V , T _J = 125 °C			10	
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 3A	5.1	6.8	8.5	mΩ
		V _{GS} = 3.8V, I _D = 3A	5.4	7.2	9	
		V _{GS} = 3.1V, I _D = 3A	5.7	7.6	9.5	
		V _{GS} = 2.5V, I _D = 3A	6.3	8.4	10.5	
		V _{GS} = 1.8V, I _D = 3A	7	11	15	
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 3A		32		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 10V, f = 1MHz		1589		pF
Output Capacitance	C _{oss}			214		
Reverse Transfer Capacitance	C _{rss}			165		
Gate Resistance	R _g	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz		2.3		Ω
Total Gate Charge ²	Q _{g(VGS=4.5V)}	V _{DS} = 10V, I _D = 3A		18.5		nC
	Q _{g(VGS=3.8V)}			16		
Gate-Source Charge ²	Q _{gs}			1.7		
Gate-Drain Charge ²	Q _{gd}			4.5		
Turn-On Delay Time ²	t _{d(on)}	V _{DD} = 10V I _D ≅ 3A, V _{GEN} = 4.5V, R _G = 6Ω		38		nS
Rise Time ²	t _r			42		
Turn-Off Delay Time ²	t _{d(off)}			60		
Fall Time ²	t _f			25		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T _J = 25 °C)						
Continuous Current ³	I _S				1.8	A
Forward Voltage ¹	V _{SD}	I _F = 3A, V _{GS} = 0V			1.2	V
Reverse Recovery Time	t _{rr}	I _F = 3A, dI _F /dt = 100A / μS		24		nS
Reverse Recovery Charge	Q _{rr}			8		nC

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

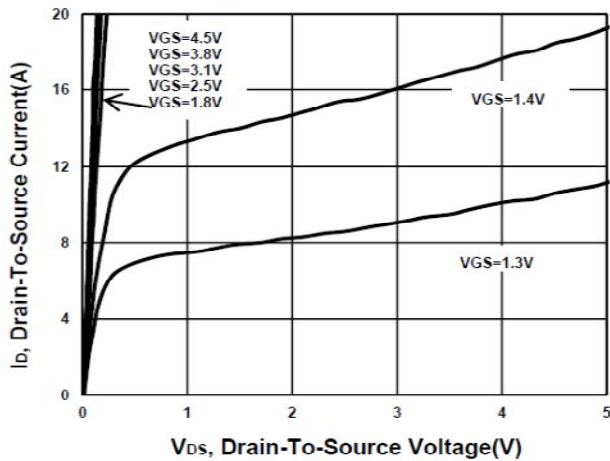
²Independent of operating temperature.

³Package limitation current is 24A.

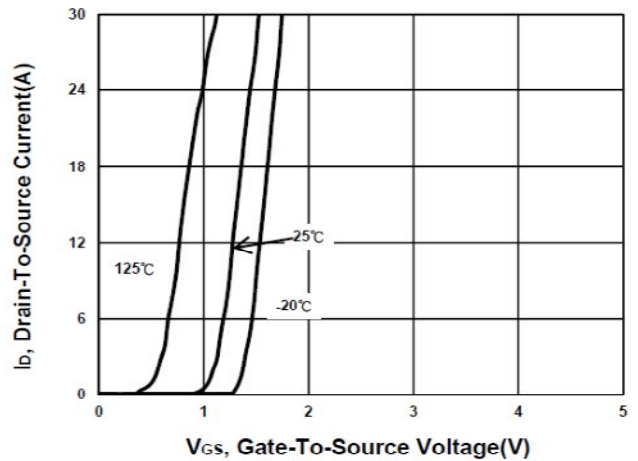
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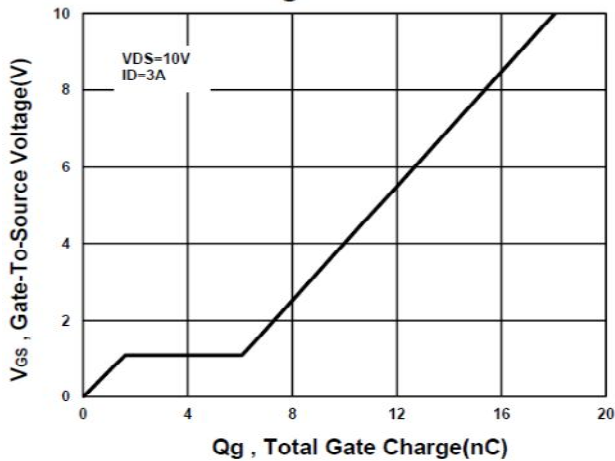
Output Characteristics



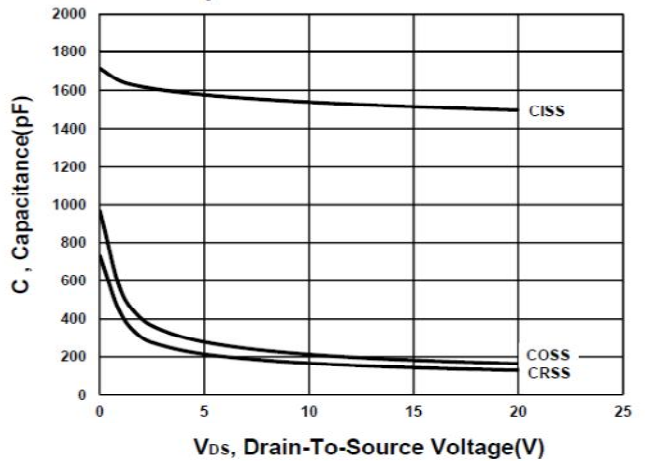
Transfer Characteristics



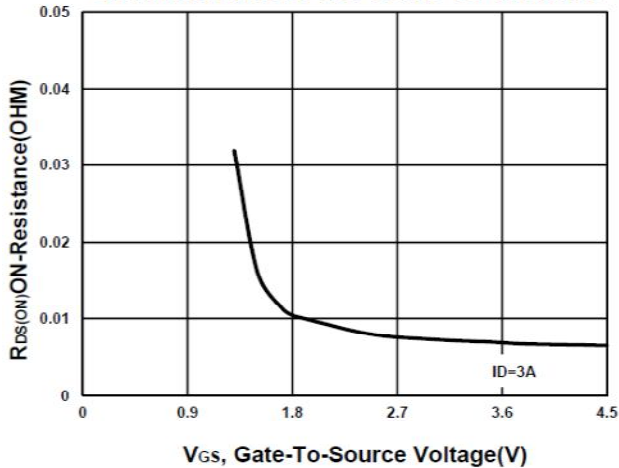
Gate charge Characteristics



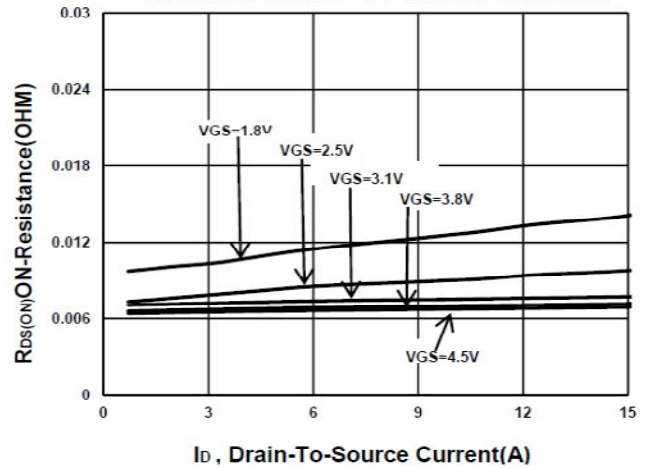
Capacitance Characteristic



On-Resistance VS Gate-To-Source



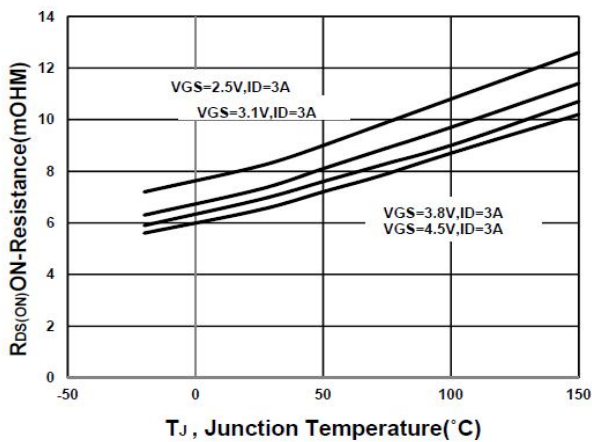
On-Resistance VS Drain Current



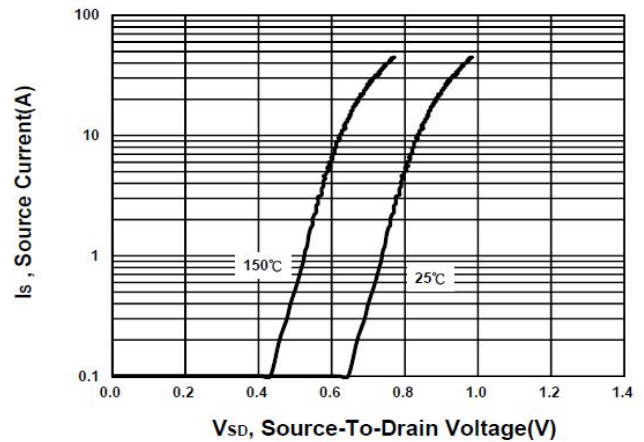
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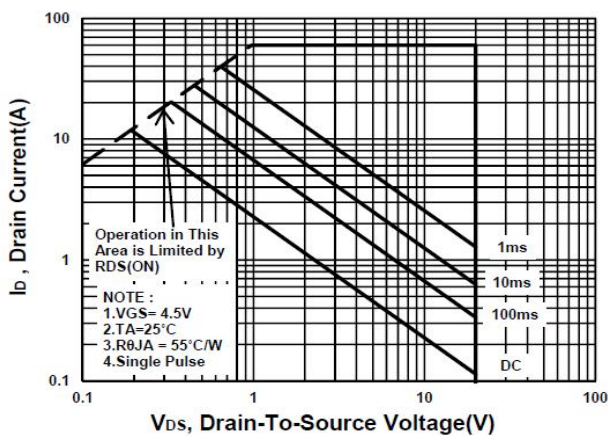
On-Resistance VS Temperature



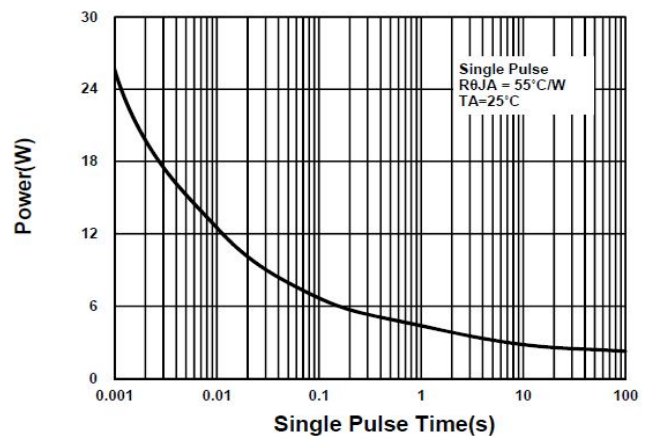
Source-Drain Diode Forward Voltage



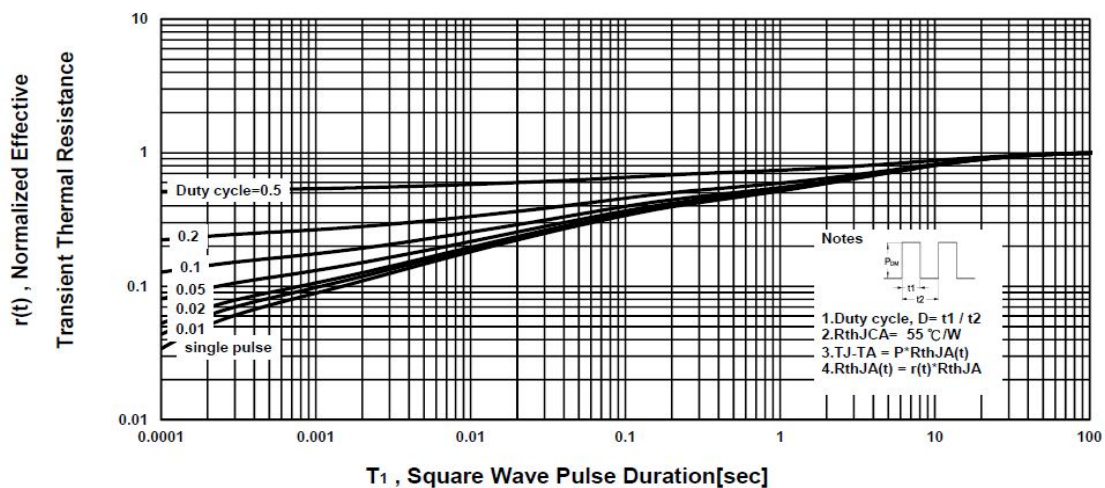
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



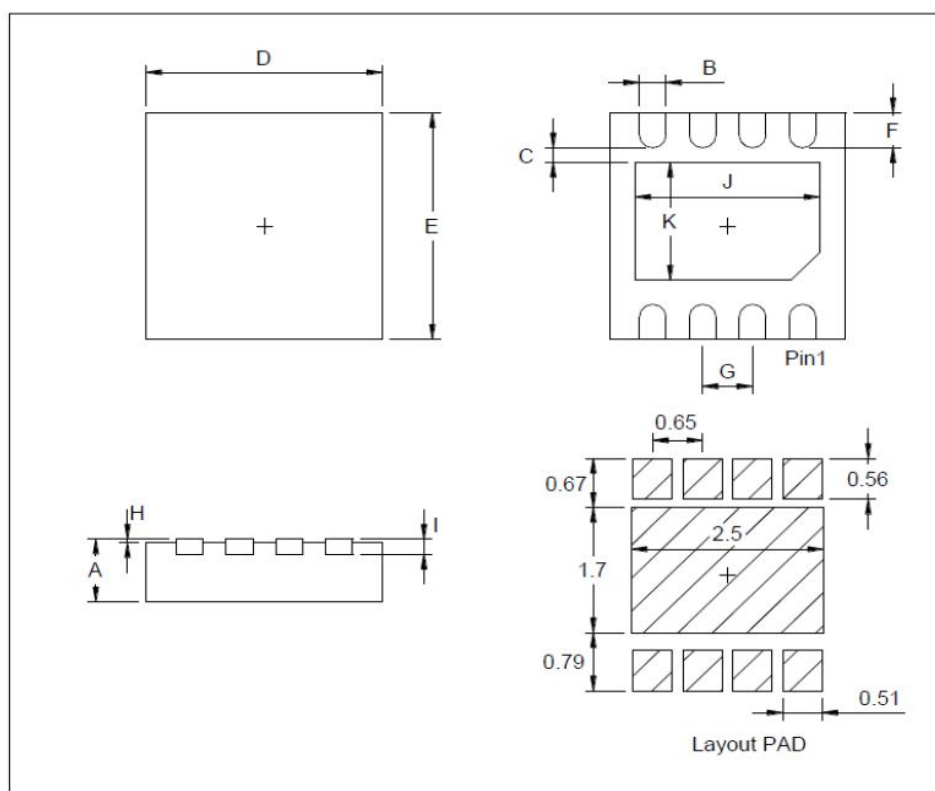
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Dual N-Channel Enhancement Mode MOSFET

Package Dimension

PDFN 3x3S MECHANICAL DATA

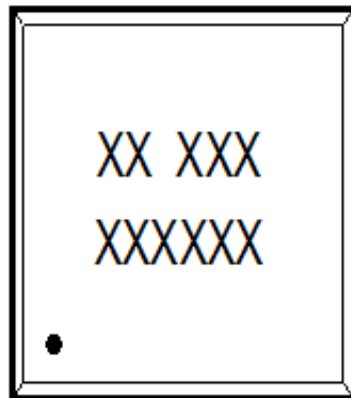
Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	0.70		0.90	I	0.195		0.211
B	0.25		0.35	J	2.20		2.40
C	0.25		0.45	K	1.40		1.60
D	2.90		3.10				
E	2.90		3.10				
F	0.324		0.476				
G	0.55	0.65	0.75				
H	0		0.05				



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Dual N-Channel Enhancement Mode MOSFET

A. Marking Information(此产品代码为: L2)

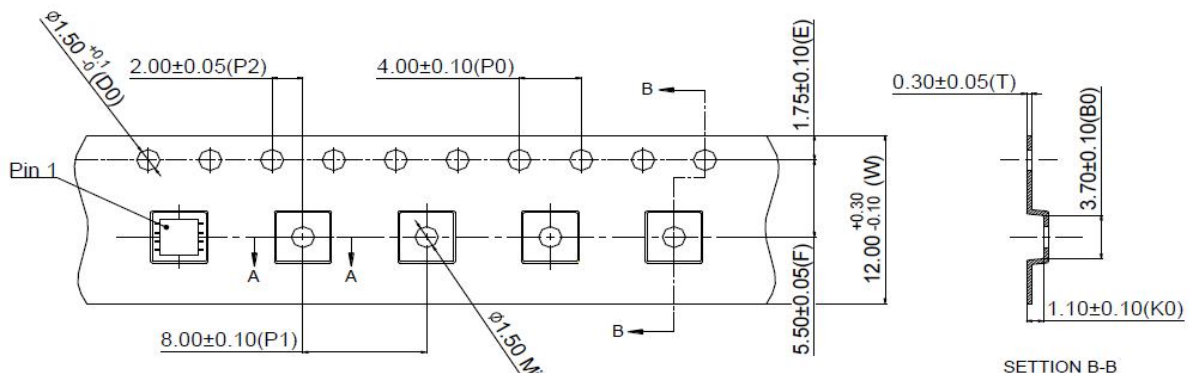


XX(前两码):产品代码

XXX

XXXXXX(后九码):LOT.NO

B. Tape&Reel Information:5000pcs/Reel

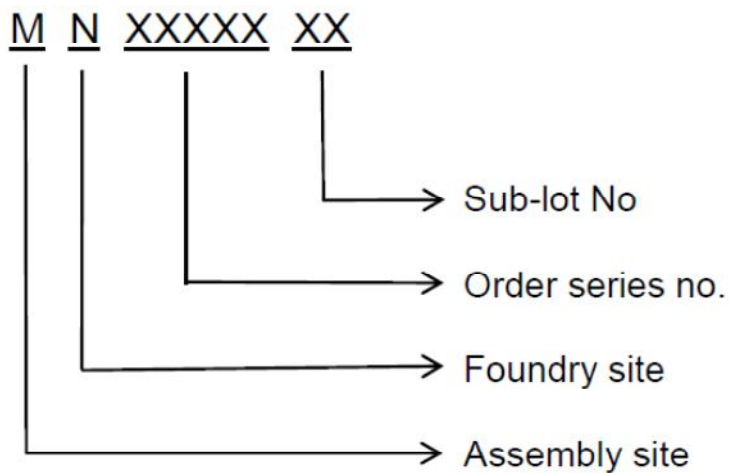


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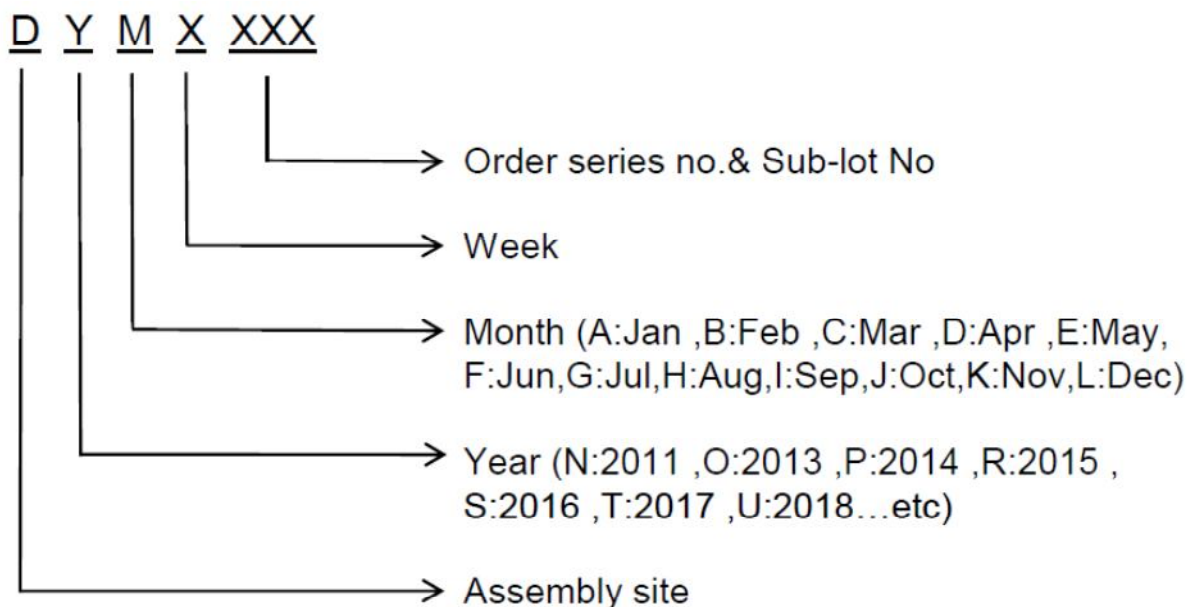
Dual N-Channel Enhancement Mode MOSFET

C. Lot No.&Date Code rule

1.Lot No.



2.Date Code





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Dual N-Channel Enhancement Mode MOSFET

D.Label rule

标签内容(Label content)



1	Label Size	30 * 90 mm
2	Font style	Times New Roman or Arial (或可区分英文"0"和数字"0", "G"和"Q"的字型即可)
3	Great Power	Height: 4 mm
4	Package	Height: 2 mm
5	Date	Height: 2 mm Shipping date: YYYY/MM/DD, ex. 2008/09/12
6	Device	Height: 3 mm (Max: 16 Digit)
7	Lot	Height: 3 mm (Max: 9 Digit) Sub lot
8	D/C	Height: 3 mm (Max: 7 Digit)
9	QTY	Height: 3 mm (Max: 6 Digit) Thousand mark is no needed
10	Pb Free label	 Diameter: 1 cm bottom color: Green Font color: Black Font style: Arial
11	Halogen Free label	 Diameter: 1 cm bottom color: Green Font color: Black Font style: Arial
12	Scan info	Device / Lot / D/C / QTY, Insert "/" between every parts. for example: P3055LDG/G12345601/GGG2301/2000 DPI (Dots per inch): Over 300 dpi Code : Code 128 Height: 6 mm at least